#### SILICON (Si) POWER MOSFET A CED4060AL



CET MOS

# CED4060AL

# 60V 🛦 60mΩ 🛦 16A 🛦 Si MOSFET

SILICON Si MOSFET ▲ THT type N-channel enhancement mode UL94V-0 rated flame retardant epoxy TO251 (E-PAK) package Super high dense cell density for extremely low R<sub>DS(ON)</sub> High power and current handling capability







#### **MAXIMUM RATINGS**

Parameter (T <sub>c</sub> = 25°C, unless otherwise noted)		Characteristics
Drain-Source Voltage	V <sub>DS</sub>	60V
Gate-Source Voltage	V <sub>GS</sub>	±20V
Continuous Drain Current at T <sub>c</sub> = 25°C	I <sub>D</sub>	16A
Pulsed Drain Current Note 1	I <sub>DM</sub>	64A
Maximum Power Dissipation at T <sub>c</sub> = 25°C	PD	38W
Power Dissipation Derating above 25°C	ΔP <sub>D</sub>	0.25W/°C
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55°C to +175°C

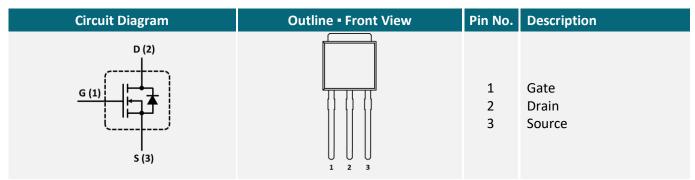
#### THERMAL CHARACTERISTICS

Parameter	Symbol	Limit
Thermal Resistance, Junction-to-Case	R <sub>TH_JC</sub>	4°C/W
Thermal Resistance, Junction-to-Ambient Note 2	R <sub>TH_JA</sub>	50°C/W

#### **APPLICATIONS**

Battery Management	DC/DC	DC	Industrial	Power
Systems	Converter	Fan	Control	Switches
+ 4 -				

#### **PIN DESCRIPTION**



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# **ELECTRICAL CHARACTERISTICS** A T<sub>c</sub> = 25°C, unless otherwise noted

Item	Condition	Symbol	Min.	Тур.	Max.	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	$V_{GS} = 0V$ , $I_D = 250\mu A$	BV <sub>DSS</sub>	60			V
Zero Gate Voltage Drain Current	$V_{DS} = 60V, V_{GS} = 0V$	I <sub>DSS</sub>			25	μA
Gate Body Leakage Current, Forward	$V_{GS}$ = 20V, $V_{DS}$ = 0V	I <sub>GSSF</sub>			100	nA
Gate Body Leakage Current, Reverse	$V_{GS}$ = -20V, $V_{DS}$ = 0V	I <sub>GSSR</sub>			-100	nA
On Characteristics Note 2						
Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	$V_{GS(th)}$	1	1.5	2	V
Static Drain-Source On-Resistance	V <sub>GS</sub> = 10V, I <sub>D</sub> = 12A	R <sub>DS(ON)</sub>		60	75	mΩ
Static Drain-Source On-Resistance	$V_{GS} = 5V, I_D = 6A$	R <sub>DS(ON)</sub>		70	90	mΩ
Forward Transconductance	V <sub>DS</sub> = 10V, I <sub>D</sub> = 6A	<b>g</b> FS		10		S
Dynamic Characteristics Note 3						
Input Capacitance	$V_{DS}$ = 25V, $V_{GS}$ = 0V, f = 1MHz	C <sub>ISS</sub>		405		рF
Output Capacitance	$V_{DS} = 25V, V_{GS} = 0V, f = 1MHz$	Coss		120		рF
Reverse Transfer Capacitance	$V_{DS}$ = 25V, $V_{GS}$ = 0V, f = 1MHz	C <sub>RSS</sub>		30		pF
Switching Characteristics Note 3						
Turn-On Delay Time	$V_{DD}$ = 30V, $V_{GS}$ = 5V, $I_D$ = 15A, $R_{G(ext)}$ = 51 $\Omega$	t <sub>D(ON)</sub>		10	13	ns
Turn-On Rise Time	$V_{DD}$ = 30V, $V_{GS}$ = 5V, $I_D$ = 15A, $R_{G(ext)}$ = 51 $\Omega$	t <sub>R</sub>		7	9	ns
Turn-Off Delay Time	$V_{DD}$ = 30V, $V_{GS}$ = 5V, $I_D$ = 15A, $R_{G(ext)}$ = 51 $\Omega$	t <sub>D(OFF)</sub>		84	110	ns
Turn-Off Fall Time	$V_{\text{DD}}$ = 30V, $V_{\text{GS}}$ = 5V, $I_{\text{D}}$ = 15A, $R_{G(ext)}$ = 51 $\Omega$	t <sub>F</sub>		22	29	ns
Total Gate Charge	$V_{DS} = 48V, V_{GS} = 10V, I_D = 15A$	$Q_{G}$		12	17	nC
Gate Source Charge	$V_{DS} = 48V, V_{GS} = 10V, I_{D} = 15A$	Q <sub>GS</sub>		1.1		nC
Gate Drain Charge	$V_{DS}$ = 48V, $V_{GS}$ = 10V, $I_{D}$ = 15A	$\mathbf{Q}_{GD}$		3.2		nC
Drain-Source Diode Characteristics a	nd Maximum Ratings					
Drain-Source Diode		ls			15	А
Forward Current Drain-Source Diode						
Forward Voltage Note 2	$V_{GS} = 0V$ , $I_S = 6A$	$V_{SD}$		0.83	1.3	V

Notes

1: Repetitive Rating: Pulse width limited by maximum junction temperature.

2: Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.

3: Guaranteed by design, not subject to production testing.

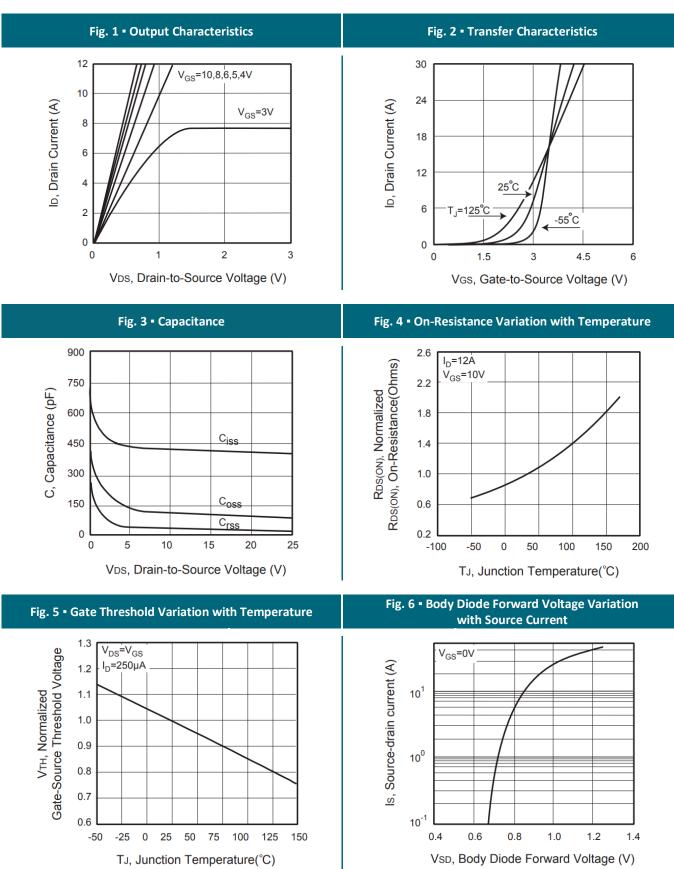


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## **REFERENCE DATA ▲ TYPICAL DEVICE PERFORMANCE**



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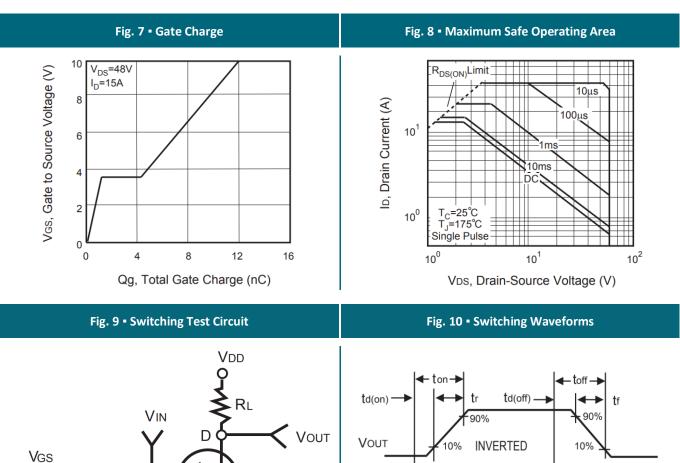
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90%

. 50% CET MOS

## **REFERENCE DATA A TYPICAL DEVICE PERFORMANCE**

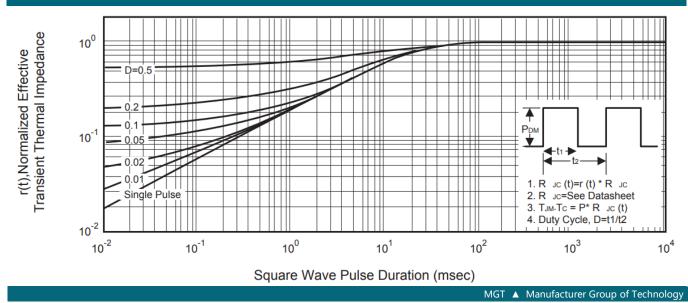


#### Fig. 11 • Normalized Thermal Transient Impedance Curve

VIN 10%

50%

PULSE WIDTH



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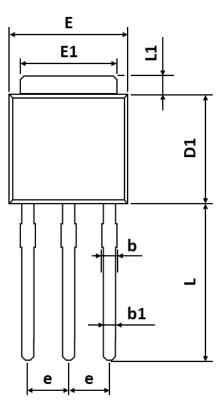
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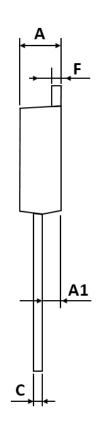
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## **PACKAGE OUTLINE**





Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)
А	2.180	-	2.400
A1	0.860	-	1.500
b	0.700	-	0.960
b1	0.700	-	0.860
С	0.400	-	0.610
D1	5.400	-	6.630
E	6.050	-	7.010
E1	4.950	-	5.460
е	1.980	-	2.590
F	0.400	-	0.890
L	8.500	-	9.650
L1	0.500	-	1.800

#### **ORDERING INFORMATION**

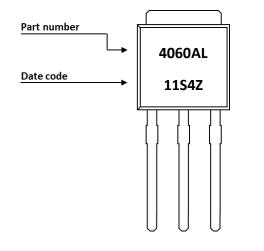
Part Number	Package	Packing	Tube Qty.	Inner Box Qty.	Outer Box Qty.
CED4060AL	TO251 (E-PAK)	Tube	80pcs	4,000pcs	16,000pcs

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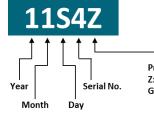
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#### **PART MARKING**



## DATE CODE

Example: 11S4Z



| Product Type Z: Pb-free G: Green Product

	Coding list for "Day"								
<b>1</b>	<b>2</b>	<b>3</b>	<b>4</b>	<b>5</b>	<b>6</b>	<b>7</b>	<b>8</b>	<b>9</b>	<b>A</b>
01	02	03	04	05	06	07	08	09	10
<b>B</b>	<b>C</b>	<b>D</b>	<b>E</b>	<b>F</b>	<b>G</b>	<b>H</b>	<b> </b>	<b>J</b>	<b>K</b>
11	12	13	14	15	16	17	18	19	20
<b>L</b>	<b>M</b>	<b>N</b>	<b>O</b>	<b>P</b>	<b>Q</b>	<b>R</b>	<b>S</b>	<b>T</b>	<b>U</b>
21	22	23	24	25	26	27	28	29	30
<b>V</b> 31									

Coding list for "Month"

<b>1</b> Jan	<b>2</b> Feb		5 May	
<b>7</b>	<b>8</b>	<b>A</b>	<b>B</b>	<b>C</b>
Jul	Aug	Oct	Nov	Dec

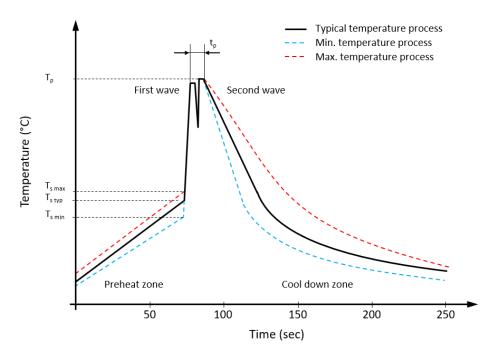
Coding list for "Year"







## **RECOMMENDED WAVE SOLDERING PROFILE ▲ THT PACKAGE**



#### Classification wave soldering profile ▲ Refer to EN 61760-1: 2006

Profile Features		Value 🛦 Sn-Pb Assembly	Value 🔺 Pb-free Assembly
Preheat temperature min.	$T_{s min}$	100 °C	100 °C
Preheat temperature typical	T <sub>s typ</sub>	120 °C	120 °C
Preheat temperature max.	$T_{s max}$	130 °C	130 °C
Preheat time $t_s$ from $T_{s min}$ to $T_{s max}$	ts	70 seconds	70 seconds
Peak temperature	Tp	235 °C to 260 °C	245 °C to 260 °C
Time of actual peak temperature	t <sub>p</sub>	Max. 10 seconds Max. 5 second each wave	Max. 10 seconds Max. 5 second each wave
Ramp-down date min.		~ 2 °C/second	~ 2 °C/second
Ramp-down rate typical		~ 3.5 °C/second	~ 3.5 °C/second
Ramp-down rate max.		~ 5 °C/second	~ 5 °C/second
Time 25°C to 25°C		4 minutes	4 minutes



## **REVISION TABLE**

Revision	Date	Status	Notes
001	30/09/2022	Initial release	Initial publication

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